



VMDSEMI

**VUSC003R270NA**

**Datasheet**



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## General Description

## Symbol

$V_{(BR)DSS}$	$R_{DS(ON)_{max}}$	$I_D$
30V	27mΩ@10V	5.8A
	30mΩ@4.5V	
	48mΩ@2.5V	

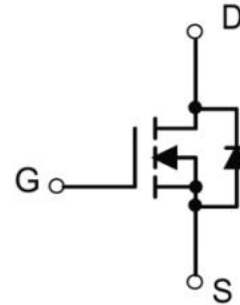


Figure 1 Symbol of VUSC003R270NA

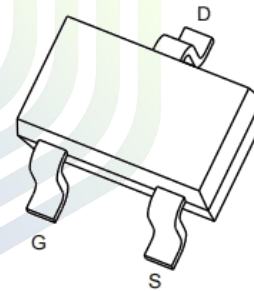
## Features

- Excellent  $R_{DS(on)}$  and Low Gate Charge
- Trench FET Power MOSFET

## Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

## Package Type



## SOT-23-3L

Figure 2 Package Type of VUSC003R270NA

## Ordering Information

Product Name	Package
VUSC003R270NA	SOT-23-3L

**Absolute Maximum Ratings** ( $T_A = 25\text{ °C}$ , unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DSS}$	30	V
Gate-Source Voltage	$V_{GSS}$	$\pm 12$	V
Continuous Drain Current <sup>Note1</sup>	$I_D$	5.8	A
Pulsed Drain Current <sup>Note2</sup>	$I_{DM}$	30	A
Total Power Dissipation <sup>Note4</sup>	$P_D$	0.4	W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55 to 150	°C

**Thermal Resistance**

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient <sup>Note5</sup>	$R_{\theta JA}$		313		°C/W



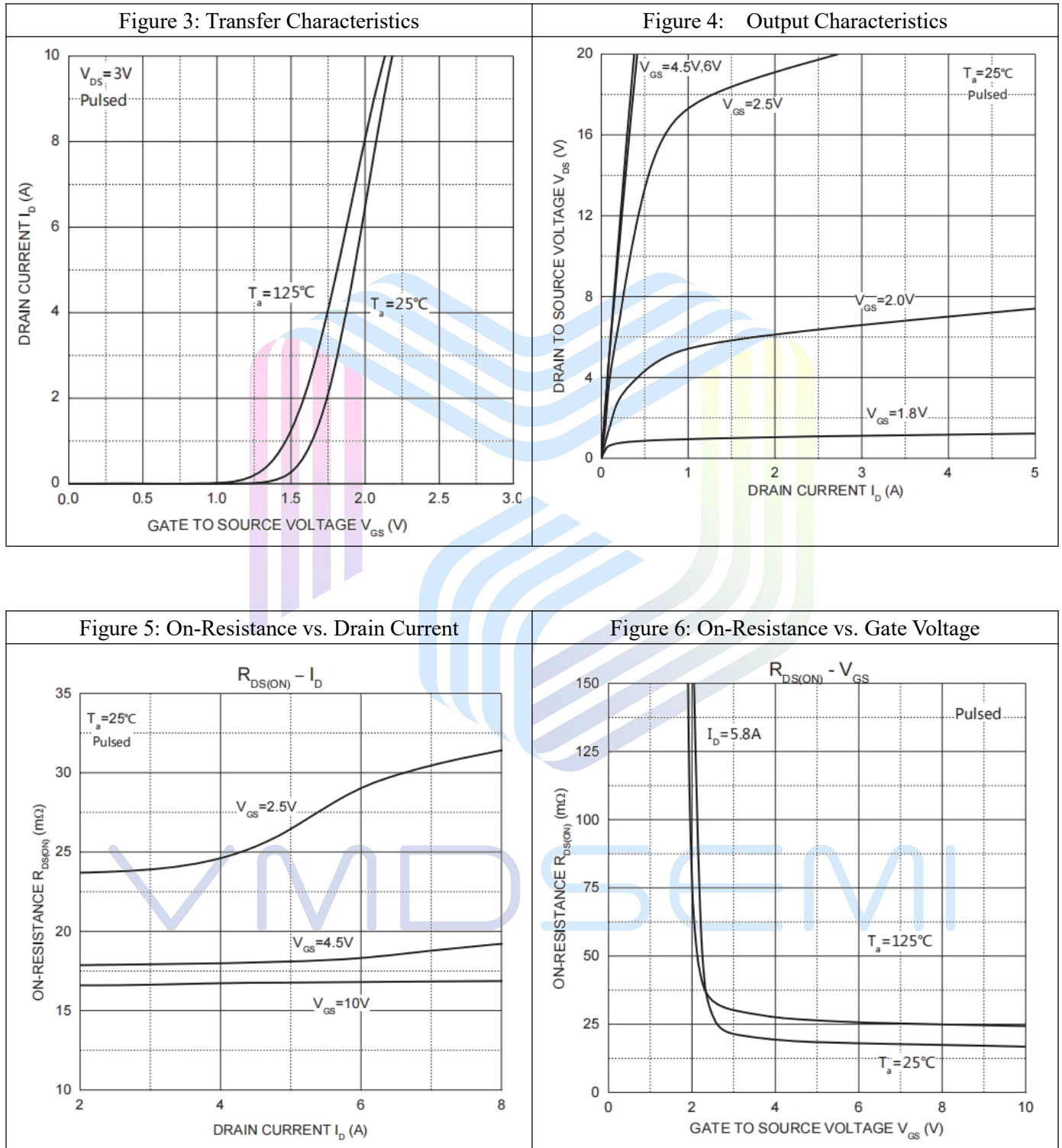
**Electrical Characteristics** ( $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

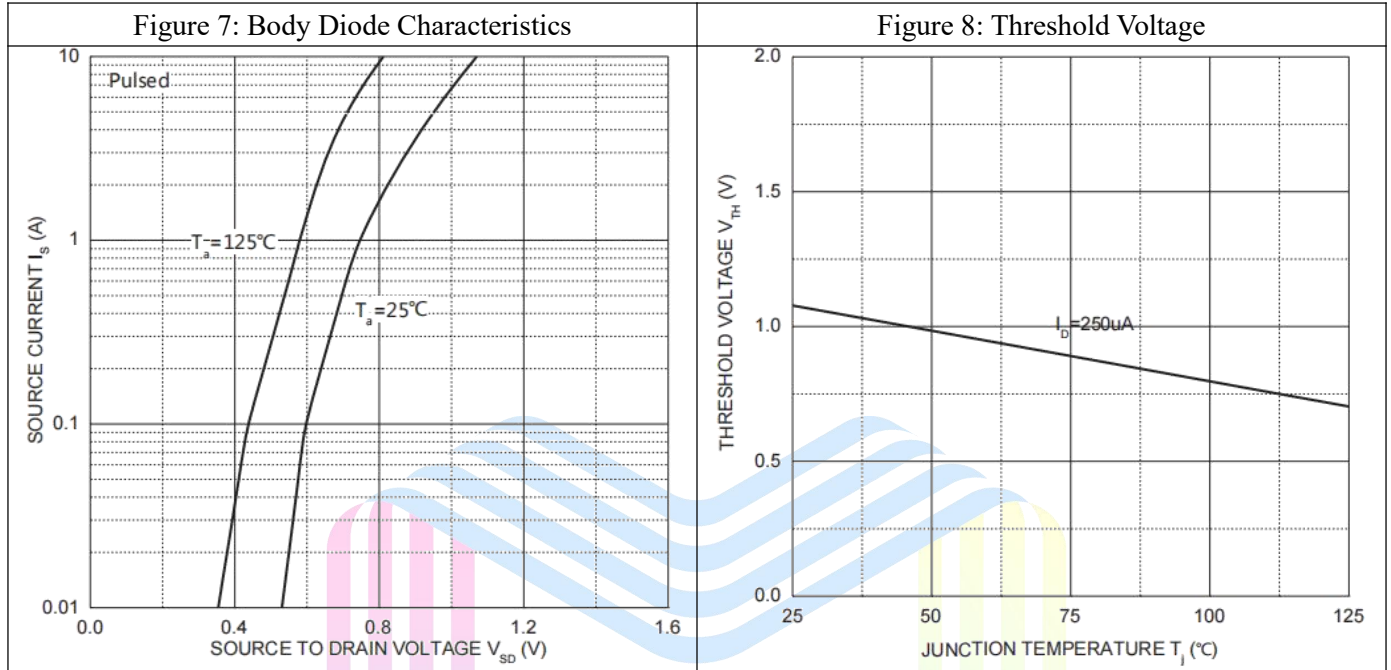
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Statistic Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	30			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=24V, V_{GS}=0V$			1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 12V, V_{DS}=0V$			$\pm 100$	nA
Gate Threshold Voltage <sup>Note3</sup>	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.7	1.0	1.4	V
Static Drain-Source On-Resistance <sup>Note3</sup>	$R_{DS(ON)}$	$V_{GS}=10V, I_D=5.8A$		20	27	mΩ
		$V_{GS}=4.5V, I_D=5.0A$		22	30	
		$V_{GS}=2.5V, I_D=4.0A$		25	48	
Forward Transconductance <sup>Note3</sup>	$g_{FS}$	$V_{DS}=5V, I_D=5.0A$	8			S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{ISS}$	$V_{DS}=15V$			1155	pF
Output Capacitance	$C_{OSS}$	$V_{GS}=0V$		108		pF
Reverse Transfer Capacitance	$C_{RSS}$	$f=1MHz$		84		pF
Gate Resistance	$R_g$	$f=1MHz, \text{open drain}$			3.6	Ω
<b>Switching Parameters</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=15V$			5	ns
Turn-on Rise Time	$t_r$	$V_{GS}=10V$			7	
Turn-off Delay Time	$t_{d(off)}$	$R_L=2.7\Omega$			40	
Turn-off Fall Time	$t_f$	$R_G=3\Omega$			6	
<b>Diode Characteristics</b>						
Diode Forward Voltage <sup>Note3</sup>	$V_{SD}$	$V_{GS}=0V, I_S=1.0A$			1.0	V

Notes :

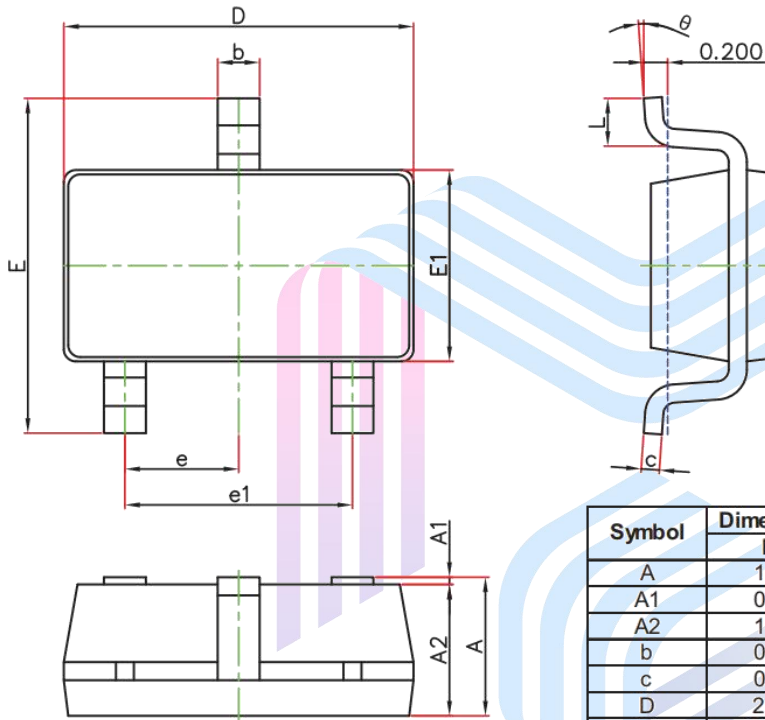
- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width  $\leq 10\mu s$ , duty cycle  $\leq 1\%$ .
- 3.Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- 4.The power dissipation  $P_D$  is limited by  $T_{J(MAX)} = 150^\circ\text{C}$ .
- 5.Device mounted on  $1\text{in}^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

## Typical Performance Characteristics





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**Mechanical Dimensions:**
**SOT-23-3L Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

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